

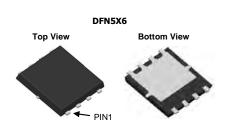
P-Channel 60 V (D-S) 175 °C MOSFET

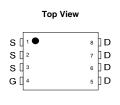
PRODUCT SUMMARY			
V _{DS} (V)	-60		
$R_{DS(on)}(\Omega)$ at $V_{GS} = -10 \text{ V}$	0.0210		
$R_{DS(on)}$ (Ω) at $V_{GS} = -4.5 \text{ V}$	0.0288		
I _D (A)	-36		
Configuration	Single		
Package	DFN 5X6		

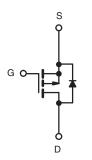
FEATURES

- Trench power MOSFET
- 100 % R_g and UIS tested









P-Channel MOSFET

ABSOLUTE MAXIMUM RATING	S (T _C = 25 °C, unless	s otherwise noted)		
PARAMETER		SYMBOL	LIMIT	UNIT	
Drain-Source Voltage		V _{DS}	-60		
Gate-Source Voltage		V _{GS}	± 20	V	
Continuous Drain Current	T _C = 25 °C	1	-36		
	T _C = 125 °C	- I _D	-21		
Continuous Source Current (Diode Conduction) ^a		I _S	-60	А	
Pulsed Drain Current b		I _{DM}	-100		
Single Pulse Avalanche Current	L = 0.1 mH	I _{AS}	-36		
Single Pulse Avalanche Energy	L = 0.1 mm	E _{AS}	64.8	mJ	
Maximum Power Dissipation ^b	T _C = 25 °C		68	W	
	T _C = 125 °C		22		
Operating Junction and Storage Temperature Range		T _J , T _{stg}	-55 to +175	°C	
Soldering Recommendations (Peak Temperature) d, e			260	-0	

THERMAL RESISTANCE RATINGS					
PARAMETER		SYMBOL	LIMIT	UNIT	
Junction-to-Ambient	PCB Mount ^c	R_{thJA}	68	°C/W	
Junction-to-Case (Drain)		R_{thJC}	2.2	C/VV	

Notes

- a. Package limited.
- b. Pulse test; pulse width $\leq 300~\mu s,$ duty cycle $\leq 2~\%.$
- c. When mounted on 1" square PCB (FR4 material).



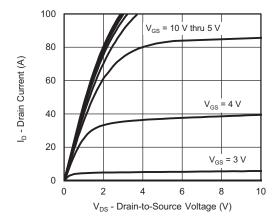
PARAMETER	SYMBOL	TES	TEST CONDITIONS		TYP.	MAX.	UNIT
Static							l
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0$, $I_D = -250 \mu A$		-60	-	-	V
Gate-Source Threshold Voltage	V _{GS(th)}	V _{DS} =	$V_{DS} = V_{GS}, I_{D} = -250 \mu A$		-2.0	-2.5	
Gate-Source Leakage	I _{GSS}	V _{DS} =	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$		-	± 100	nA
		$V_{GS} = 0 V$	V _{DS} = -60 V	-	-	-1	
Zero Gate Voltage Drain Current	I _{DSS}	V _{GS} = 0 V	V _{DS} = -60 V, T _J = 125 °C	-	-	-50	μΑ
		V _{GS} = 0 V	V _{DS} = -60 V, T _J = 175 °C	-	-	-150	
On-State Drain Current ^a	I _{D(on)}	V _{GS} = -10 V	$V_{DS} \ge -5 \text{ V}$	-30	-	-	Α
Drain-Source On-State Resistance ^a		V _{GS} = -10 V	I _D = -10 A	-	0.0210	-	Ω
		V _{GS} = -10 V	I _D = -10 A, T _J = 125 °C	-	0.0409	-	
	R _{DS(on)}	V _{GS} = -10 V	I _D = -10 A, T _J = 175 °C	-	0.0504	-	
		$V_{GS} = -4.5 \text{ V}$	I _D = -5 A	-	0.0288	-	
Forward Transconductance b	9fs	$V_{DS} = -15 \text{ V}, I_{D} = -10 \text{ A}$		-	26	-	S
Dynamic ^b							
Input Capacitance	C _{iss}		V _{DS} = -25 V, f = 1 MHz	-	2600	3400	pF
Output Capacitance	C _{oss}	$V_{GS} = 0 V$		-	310	450	
Reverse Transfer Capacitance	C _{rss}			-	200	275	
Total Gate Charge ^c	Qg		V _{DS} = -30 V, I _D = -5 A	-	65	100	
Gate-Source Charge ^c	Q_{gs}	$V_{GS} = -10 \text{ V}$		-	9.5	-	nC
Gate-Drain Charge ^c	Q_{gd}			-	19	-	
Gate Resistance	R_g	f = 1 MHz		0.50	1.19	1.80	Ω
Turn-On Delay Time ^c	t _{d(on)}			-	15	25	
Rise Time ^c	t _r	$V_{DD} = -30 \text{ V}, \text{ R}_L = 6 \Omega$ $I_D \cong -5 \text{ A}, \text{ V}_{GEN} = -10 \text{ V}, \text{ R}_g = 1 \Omega$		-	5	10	ns
Turn-Off Delay Time ^c	t _{d(off)}			-	40	75	
Fall Time ^c	t _f			-	6	12	
Source-Drain Diode Ratings and Chara	cteristics ^b						
Pulsed Current ^a	I _{SM}			-	-	-100	Α
Forward Voltage	V_{SD}	I _F = -10 A, V _{GS} = 0 V		-	-0.80	-1.2	V

Notes

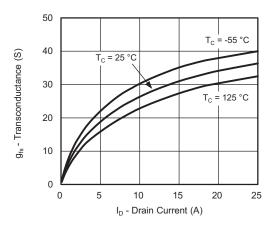
- a. Pulse test; pulse width $\leq 300~\mu s,$ duty cycle $\leq 2~\%.$
- b. Guaranteed by design, not subject to production testing.c. Independent of operating temperature.



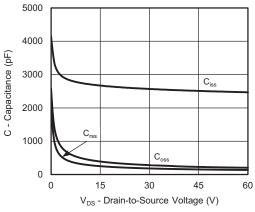
TYPICAL CHARACTERISTICS ($T_A = 25$ °C, unless otherwise noted)



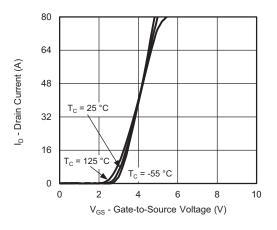
Output Characteristics



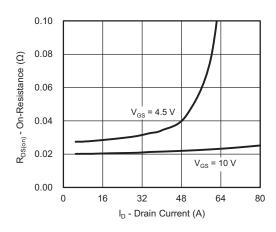
Transconductance



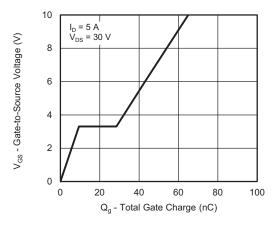
Capacitance



Transfer Characteristics



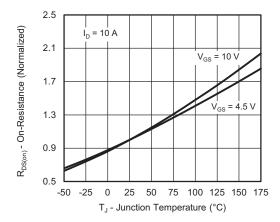
On-Resistance vs. Drain Current



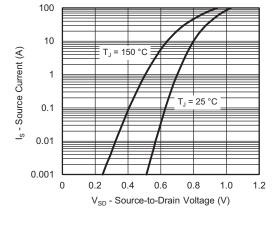
Gate Charge



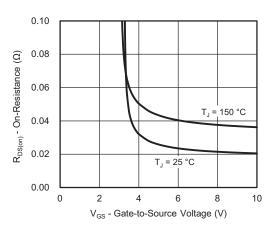
TYPICAL CHARACTERISTICS ($T_A = 25 \, ^{\circ}C$, unless otherwise noted)



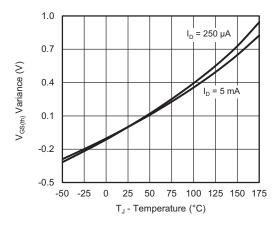
On-Resistance vs. Junction Temperature



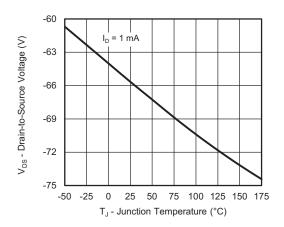
Source Drain Diode Forward Voltage



On-Resistance vs. Gate-to-Source Voltage



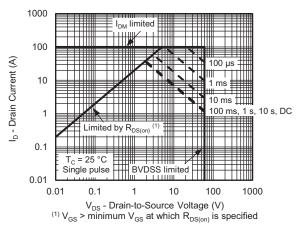
Threshold Voltage



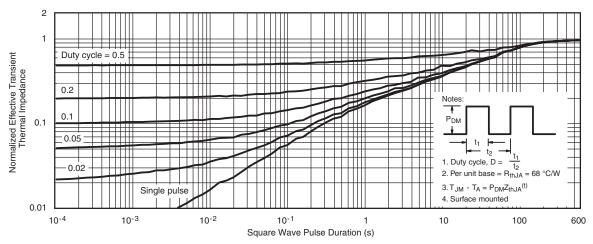
Drain-Source Breakdown vs. Junction Temperature



THERMAL RATINGS ($T_C = 25$ °C, unless otherwise noted)



Safe Operating Area

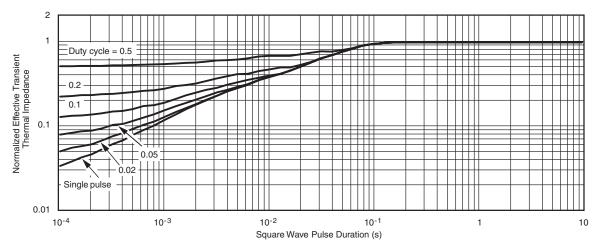


Normalized Thermal Transient Impedance, Junction-to-Ambient

服务热线:400-655-8788 5



THERMAL RATINGS (T_C = 25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Case

Note

- The characteristics shown in the two graphs
 - Normalized Transient Thermal Impedance Junction-to-Ambient (25 °C)
 - Normalized Transient Thermal Impedance Junction-to-Case (25 °C) are given for general guidelines only to enable the user to get a "ball park" indication of part capabilities. The data are extracted from single pulse transient thermal impedance characteristics which are developed from empirical measurements. The latter is valid for the part mounted on printed circuit board FR4, size 1" x 1" x 0.062", double sided with 2 oz. copper, 100 % on both sides. The part capabilities can widely vary depending on actual application parameters and operating conditions.



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